TSCDH20065G1 Taiwan Semiconductor

20A, 650V SiC Merged PIN Schottky Diode

FEATURES

- Max junction temperature 175°C
- MPS structure for high ruggedness to forward current surge events
- High-speed switching possible
- High forward surge capability
- High-frequency operation
- Positive temperature coefficient on V_F
- RoHS compliant
- Halogen-free

APPLICATIONS

- General purpose
- Switch mode power supplies
- Power factor correction

MECHANICAL DATA

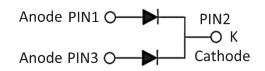
- Case: TO-247-3L
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Polarity: As circuit diagram
- Weight: 6.28g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
lF	20	А	
V _{RRM}	650	V	
IFSM	88	А	
T _{J MAX}	175	°C	
Package	TO-247-3L		
Configuration	Common cathode		





TO-247-3L



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	VALUE	UNIT
Repetitive peak reverse voltage		Vrrm	650	V
Reverse voltage, total rms value		V _{R(RMS)}	455	V
Continuous Rectified Forward Current @ T _J = 160°C per leg / per device		lF	10 / 20	А
Surge peak forward current 10ms single half sine-wave superimposed on rated load	$T_C = 25^{\circ}C$	IFSM	88	Α
	Tc = 125°C		76	Α
Junction temperature		TJ	-55 to +175	°C
Storage temperature		T _{STG}	-55 to +175	°C





THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ΤΥΡ	MAX	UNIT
Junction-to-case thermal resistance per leg	R _{ejc}	0.93	1.12	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage per leg ⁽¹⁾	$I_F = 5A, T_J = 25^{\circ}C$	VF	1.16	-	V
	$I_F = 10A, T_J = 25^{\circ}C$		1.34	1.45	V
	$I_F = 5A, T_J = 150^{\circ}C$		1.19	-	V
	$I_F = 10A, T_J = 150^{\circ}C$		1.57	-	V
	$I_F = 5A, T_J = 175^{\circ}C$		1.22	-	V
	$I_F = 10A, T_J = 175^{\circ}C$		1.65	1.85	V
Poweree europt @ reted V- per log ⁽²⁾	$T_J = 25^{\circ}C$	1-	-	20	μA
Reverse current @ rated V _R per leg ⁽²⁾	T _J = 175°C	IR	-	200	μA
Junction capacitance per leg	$f = 1MHz, V_R = 1V$	CJ	476	-	pF
	$f = 1MHz, V_R = 200V$		74.0	-	pF
	$f = 1MHz, V_R = 400V$		52.3	-	pF
Capacitive Charge per leg	V _R = 400V	Qc	35.4	-	nC

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TSCDH20065G1	TO-247-3L	30 / Tube	



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

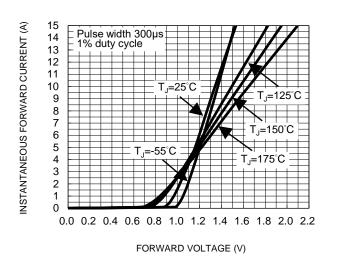


Fig.1 Typical Forward Characteristics

Fig.3 Peak forward current versus case temperature

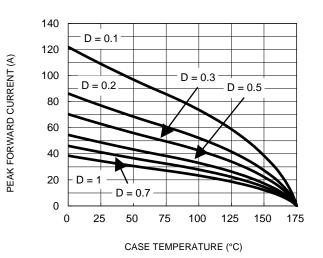
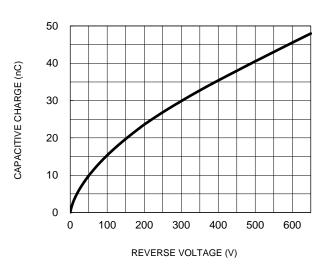
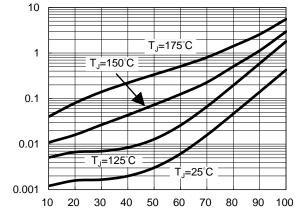


Fig.5 Typical Capacitive Charge





PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

Fig.4 Typical Junction Capacitance

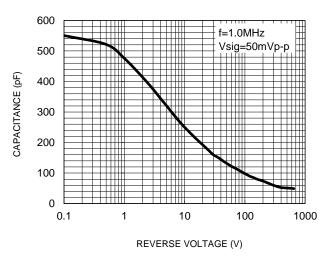
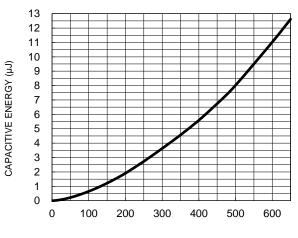


FIG.6 Typical Capacitance Stored Energy



REVERSE VOLTAGE (V)

Fig.2 Typical Reverse Characteristics

INSTANTANEOUS REVERSE CURRENT (µA)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

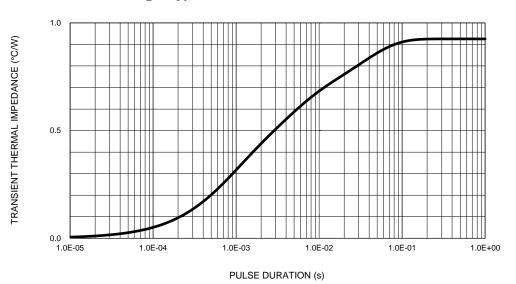
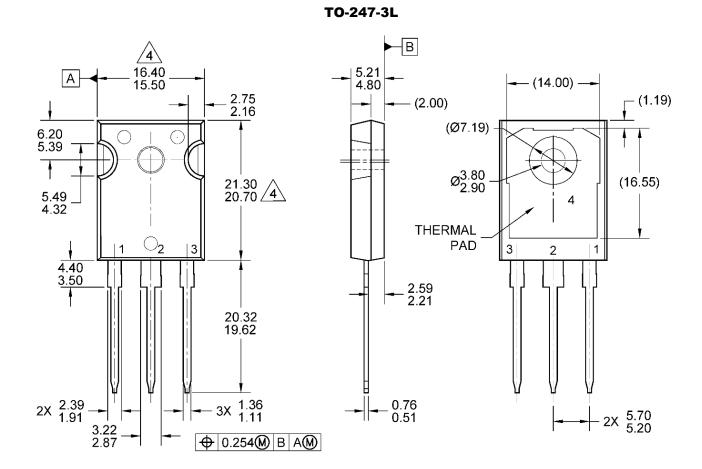
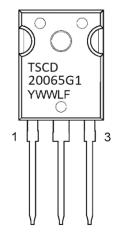


Fig.7 Typical Transient Thermal Characteristics



PACKAGE OUTLINE DIMENSIONS





MARKING DIAGRAM

- Y = YEAR CODE
- WWW = WEEK CODE (01~52)
- L = LOT CODE (1~9, A~Z)
- F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-247, VARIATION AD, ISSUE E.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
- 5. DWG NO. REF: HQ2SD07-TO247ADSiC-122 REV A.



TSCDH20065G1

Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.